form no. 7530-001-103

15.9 REF P/N WIRE NUMBERS LOADED PLATING 304 " G.X.T. ALL 91139-088 8.89 504 " G.X.T. 91139-588 ALL 1.27 TYP ALL 30u 91139-088LF G.X.T. -ø0.89 TYP 91139-588LF ALL 504 " G.X.T. LEAD FREE PRODUCT NO. 1.02 TYP. ø2.0 TYP(2) -ø3.20 TYP(2) 1.270 2.01 11.43 15.44 RECOMMENDED PC BOARD LAYOUT 50 ø3.05 \circ NOTES: 220 1. RECOMMENDED P.C.B THICKNESS 1.60 MM 20±0. 2. HOUSING MAT'L: NYLON 66,25% G.F UL 94V-0, BLACK. 3. CONTACTS: PHOS BRONZE ALLOY UNS-C51000. M) 0.46 TYP 3.89 ø3.556 Ø 0.460 ROUND WIRE, PLATING SEE TABLE. 8.89 4. METAL SHELL MATERIAL: 6.35 COPPER ALLOY, 0.20mm THICK 0.20 THICK 1.27 TYP 8.89 METAL SHIELD FOR 91139-XXX FINISH: TIN-LEAD 1004 " THICK MIN. 10.11 FOR 91139-XXXLF M/J ASSY 10 FINISH: UNDERPLATING WITH 50u" MIN. NICKEL FÓR VERT. OVERPLATING WITH 80u" MIN PURE BRIGHT TIN 5. PACKAGING: GES-14-351, USE TRAY 6. ALL DIMENSIONS IN MINIMETER. 7. IF LF P/N THE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008 mat'l. code // Electronics tolerances unless 8. IF LF P/N THE HOUSING WILL WITHSTAND EXPOSURE CUSTOMER otherwise specified COPY **■** FCI TO 260°C PEAK TEMPERATURE FOR 10 SECONDS www.fciconnect.com Itr ecn no dr date .X ±.25 O O. IN A WAVE SOLDER APPLICATION WITH A 1.60mm T50107 C L 4/17/95 .XX ±.13 8 POS VERT PCB. M/J ASSY T50355 C L 11/23/95 .XXX ±.05 $\oplus \triangleleft$ MINIMUM THICK CIRCUIT BOARD SHIELDED, WITHOUT PANEL STOP 0° ±2° 9. IF LF P/N PACKAGING MEETS GS-14-920 SPECIFICATION C L FENG 4/17/'95 product family T90381 JSR 11/10/99 dr code mm E T03-0443 WL 10/06/03 engr size dwg no TONY CHIEN 4/17/'95 F N04-0040 ZC 08/16/04 chr TONY CHIEN 4/17/'95 scale sheet 11.43 91139 G NO4-0115 YS 12/06/04 appd JENN TSAO 4/17/'95 3:1 1 of 1 revision G

2

sheet

PDM: Rev:G

STATUS: Released

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